

2MBI450VH-120-50

IGBT Modules

IGBT MODULE (V series) 1200V / 450A / 2 in one package

■ Features

High speed switching Voltage drive Low Inductance module structure

Applications

Inverter for Motor Drive AC and DC Servo Drive Amplifier Uninterruptible Power Supply Industrial machines, such as Welding machines



Maximum Ratings and Characteristics

■ Absolute Maximum Ratings (at Tc=25°C unless otherwise specified)

Items	Symbols	Conditions	Conditions		Units	
Collector-Emitter voltage	Vces				V	
Gate-Emitter voltage	V _{GES}			±20	V	
Collector current	Ic	Continuous	Tc=100°C	450		
		Continuous	Tc=25°C	520		
	Ic pulse	1ms		900	Α	
	-lc					
	-lc pulse	1ms	1ms			
Collector power dissipation	Pc	1 device	1 device		W	
Junction temperature	Tj				°C	
Operating junction temperature (under switching conditions	ing junction temperature (under switching conditions) T _{jop}			150		
Case temperature	Tc			125	C	
Storage temperature	Tstg					
Isolation voltage Between terminal and copper base (*1)	Viso	AC: 1min.		2500	VAC	
Sorow torque Mounting (*2)				6.0	N m	
Screw torque Terminals (*3)]-			5.0	IN III	

Note *1: All terminals should be connected together during the test. Note *2: Recommendable Value : 3.0-6.0 Nm (M5 or M6) Note *3: Recommendable Value : 2.5-5.0 Nm (M6)

● Electrical characteristics (at Ti= 25°C unless otherwise specified)

Items	Cumbala	Conditions	0 111		Characteristics		
	Symbols	Conditions		min.	typ.	max.	Units
Zero gate voltage collector current	Ices	V _{GE} = 0V, V _{CE} = 1200V		-	-	2.0	mA
Gate-Emitter leakage current	Iges	$V_{CE} = 0V, V_{GE} = \pm 20V$		-	-	400	nA
Gate-Emitter threshold voltage	V _{GE (th)}	V _{CE} = 20V, I _C = 450mA		6.0	6.5	7.0	V
Collector-Emitter saturation voltage	V		Tj=25°C	-	2.10	2.45	V
	V _{CE (sat)}	V _{GE} = 15V I _C = 450A	Tj=125°C	-	2.45	-	
	(terminal)		Tj=150°C	-	2.50	-	
	.,		Tj=25°C	-	1.80	2.15	
	V _{CE} (sat)		Tj=125°C	-	2.15	-	
	(chip)		Tj=150°C	-	2.20	-	
Input capacitance	Cies	V _{CE} = 10V, V _{GE} = 0V, f = 1MHz		-	36	-	nF
Turn-on time	ton	Vcc = 600V Ls = 30nH		-	0.60	-	μs
	tr	Ic = 450A	-	0.20	-		
	tr (i)	V _{GE} = ±15V	-	0.05	-		
Turn-off time	toff	$R_G = 1\Omega$		-	0.80	-	
	tf	⊤j = 150°C	-	0.08	-		
Forward on voltage	.,		Tj=25°C	-	1.95	2.40	V
	V _F		Tj=125°C	-	2.15	-	
	(terminal)	V _{GE} = 0V	Tj=150°C	_	2.10	-	
	.,	I _F = 450A	Tj=25°C	-	1.70	2.15	
	V _F		Tj=125°C	-	1.90	-	
	(chip)		Ti=150°C	-	1.85	-	
Reverse recovery time	trr	I _F = 450A, Tj=150°C	,	-	0.15	_	μs

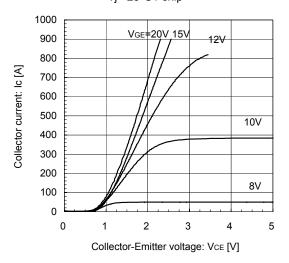
Thermal resistance characteristics

Items	Symbols	Conditions	Ch	Characteristics			
			min.	typ.	max.	Units	
Thermal resistance (1device)	Dth(i o)	Inverter IGBT	-	-	0.062	°C/W	
	Rth(j-c)	Inverter FWD	-	-	0.110		
Contact thermal resistance (1device) (*4)	Rth(c-f)	with Thermal Compound	_	0.0125	_	1	

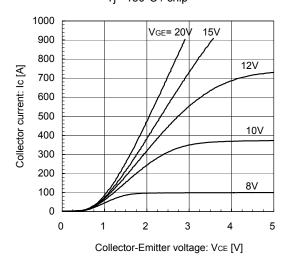
Note *4: This is the value which is defined mounting on the additional cooling fin with thermal compound.

■ Characteristics (Representative)

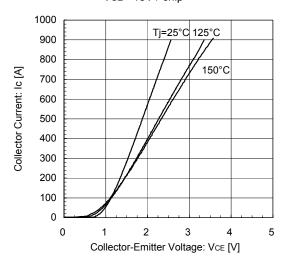
Collector current vs. Collector-Emitter voltage (typ.) Tj= 25°C / chip



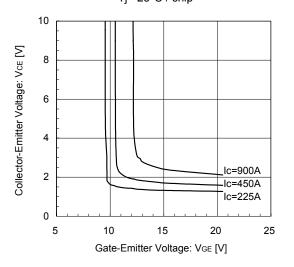
Collector current vs. Collector-Emitter voltage (typ.) Tj= 150°C / chip



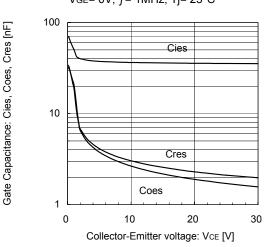
Collector current vs. Collector-Emitter voltage (typ.) VGE= 15V / chip



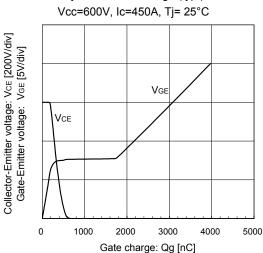
Collector-Emitter voltage vs. Gate-Emitter voltage (typ.) Tj= 25°C / chip



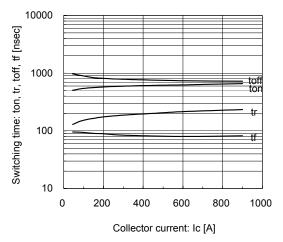
Gate Capacitance vs. Collector-Emitter Voltage (typ.) VGE= 0V, f= 1MHz, Tj= 25°C



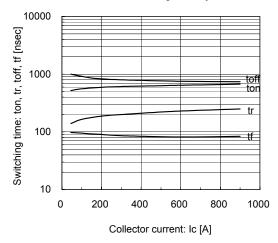
Dynamic Gate Charge (typ.)



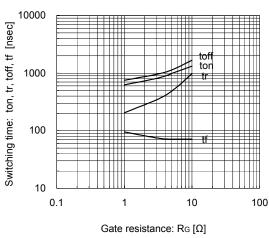
Switching time vs. Collector current (typ.) Vcc=600V, VgE= \pm 15V, Rg=1 Ω , Tj=125°C



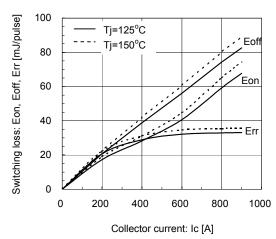
Switching time vs. Collector current (typ.) Vcc=600V, VgE= \pm 15V, Rg=1 Ω , Tj=150°C



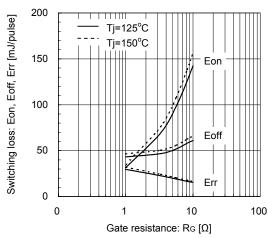
Switching time vs. Gate resistance (typ.) Vcc=600V, Ic=450A, VGE=±15V, Tj=125°C



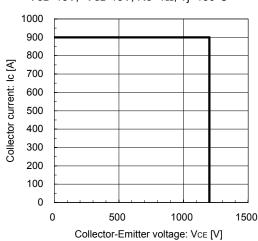
Switching loss vs. Collector current (typ.)
Vcc=600V, VgE=±15V, Rg=1Ω, Tj=125°C, 150°C



Switching loss vs. Gate resistance (typ.) Vcc=600V, Ic=450A, VgE= \pm 15V, Tj=125°C, 150°C



Reverse bias safe operating area (max.) +VGE=15V, -VGE=15V, RG=1 Ω , Tj=150°C



Forward current: IF [A]

400

0

chip

1000
900
800
700
600
500

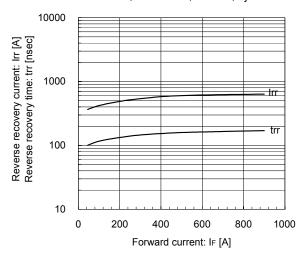
Forward Current vs. Forward Voltage (typ.)

150°C

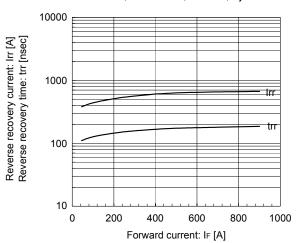
Forward on voltage: VF [V]

3

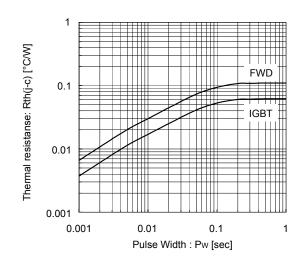
Reverse Recovery Characteristics (typ.) Vcc=600V, $VgE=\pm15V$, $Rg=1\Omega$, $Tj=125^{\circ}C$



Reverse Recovery Characteristics (typ.) Vcc=600V, $VgE=\pm15V$, $Rg=1\Omega$, $Tj=150^{\circ}C$

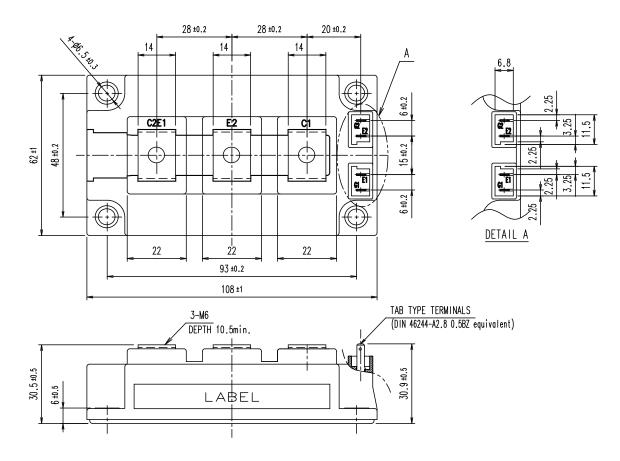


Transient Thermal Resistance (max.)

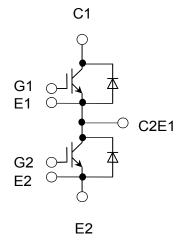


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■ Outline Drawings, mm



■ Equivalent Circuit Schematic



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- Measurement equipment

- Machine tools
- Audiovisual equipment
- Electrical home appliances Persona
- Personal equipment
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